SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)

Application No.	10/555,467
Filing Date:	April 30, 2004
First Name Inventor	Cheung Hoi Yu
Art Unit	1637
Examiner Name	Chunduru, Suryaprabha
Attorney Docket No.	2055.043

U.S. PATENTS

Examiner Initials	Cite No.	Patent Number	Kind Codel	Issue Date	Name of Patentee or applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Pigures Appear
	A					

U.S. PATENT APPLICATION PUBLICATIONS

Examii Initia		Publication Number	Kind Code ¹	Publication Date	Name of Patentee or applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	В					

FOREIGN PATENT DOCUMENTS

Examiner Initials	Cite No.	Foreign Document Number ³	Country Code ²	Kind Code ⁴	Publication Date	Name of Patentee or applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Figures Appear	Translation Yes No
	CA	CN 1442488	CN	A	2003-09-17	Shanghai Jingtai Biotechnology		

NON-PATENT LITERATURE DOCUMENTS

Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, page(s), volume-issue number(s), publisher, city and/or country where published.
	D	
	<u> </u>	Date Considered

EXAMINER:

Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP Section 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

⁴ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible.

¹ See Kind Codes of USPTO Patent Documents at <u>www.USPTO.GOV</u> or MPEP 901.04. ² Enter office that issued the document, by the two-letter code (WIPO Standard ST.3) ³ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document.